Power Inductor



BPCI Series



Overview

Power inductors are passive electronic components used in various circuits to store energy in a magnetic field when electrical current flows through them. They are critical in filtering, energy storage, and noise suppression in power electronic systems.

They are designed to handle higher currents and are optimized for minimal power loss and thermal efficiency.

Benefits

- 1. Ferrite SMD Shielded Type
- 2. Various package size and wide inductance range

Applications

- 1. AP Routers, STBs
- 2. LCD TVs and monitors
- 3. Game consoles
- 4. LED lightings
- 5. DC/DC converters

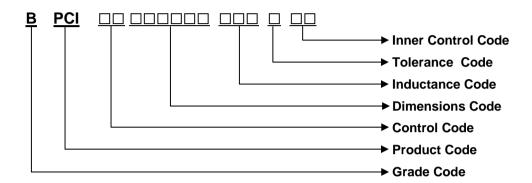
Product Information

Series	L <u>(mm)</u>	W <u>(mm)</u>	T <u>(mm)</u>	Inductance (μH)
BPCI	7.3	7.3	4.6	0.33 ~ 10000
	12.0	12.0	5.0	
	12.0	12.0	6.0	
	12.0	12.0	8.0	
	12.0	12.0	10.0	





- 1 Scope: This specification applies to the Pb Free high current type SMD inductors
- 2 Part Numbering:



3 Rating:

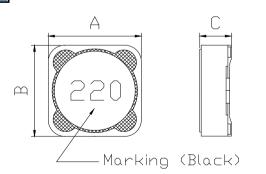
Operating Temperature: $-40^{\circ}\text{C} \sim 125^{\circ}\text{C}(\text{Including self - temperature rise})$

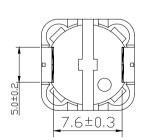
Storage Temperature(on tape & reel): -20°C to +40°C; 75% RH max.

4 Standard Testing Condition:

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°ℂ
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

5 Configuration and Dimensions:





A: 12.0±0.5 mm

B: 12.0±0.5 mm

C: 6.0 Max. mm

Net Weight (grms)

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SIZE CODE	Net Weight (grms)			
121260	3.12(Typ.)			

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6 Electrical Characteristics:

Part No.	Inductance L(µH)	Test Frequency	Resistance RDC(Ω) Max.	Rated DO	C Current Irms(A)	Tolerance	Marking
BPCI001212602R2 00	2.2	100kHz/0.25V	15m	6.50	6.50	Т	2R2
BPCI001212602R4 00	2.4	100kHz/0.25V	15m	6.50	6.50	Т	2R4
BPCI001212602R7 00	2.7	100kHz/0.25V	15m	6.50	6.50	Т	2R7
BPCI001212603R3 00	3.3	100kHz/0.25V	17m	6.00	6.00	M,T	3R3
BPCI001212603R9=00	3.9	100kHz/0.25V	18m	5.70	5.70	Т	3R9
BPCI001212604R7 = 00	4.7	100kHz/0.25V	20m	5.00	5.00	Т	4R7
BPCI001212606R8 = 00	6.8	100kHz/0.25V	23m	4.30	4.30	M,T	6R8
BPCI001212608R2 = 00	8.2	100kHz/0.25V	24m	4.20	4.20	M,T	8R2
BPCI00121260100 00	10	100kHz/0.25V	25m	4.00	4.00	M,T	100
BPCI00121260120 00	12	100kHz/0.25V	27m	3.50	3.50	M,T	120
BPCI00121260150 00	15	100kHz/0.25V	30m	3.30	3.30	M,T	150
BPCI00121260180 00	18	100kHz/0.25V	34m	3.00	3.00	M,T	180
BPCI00121260220 00	22	100kHz/0.25V	36m	2.80	2.80	M,T	220
BPCI00121260270 00	27	100kHz/0.25V	51m	2.30	2.30	M,T	270
BPCI00121260330 00	33	100kHz/0.25V	57m	2.10	2.10	M,T	330
BPCI00121260390 00	39	100kHz/0.25V	68m	2.00	2.00	M,T	390
BPCI00121260470 00	47	100kHz/0.25V	75m	1.80	1.80	M,T	470
BPCI00121260560 00	56	100kHz/0.25V	0.11	1.70	1.70	M,T	560
BPCI00121260680 00	68	100kHz/0.25V	0.12	1.50	1.50	M,T	680
BPCI00121260820 00	82	100kHz/0.25V	0.14	1.40	1.40	M,T	820
BPCI0012126010100	100	100kHz/0.25V	0.16	1.30	1.30	K,M	101
BPCI00121260121000	120	100kHz/0.25V	0.17	1.10	1.10	K,M	121
BPCI00121260151000	150	100kHz/0.25V	0.23	1.00	1.00	K,M	151
BPCI00121260181000	180	100kHz/0.25V	0.29	0.90	0.90	K,M	181
BPCI00121260221 00	220	100kHz/0.25V	0.40	0.80	0.80	K,M	221

NOTE: tolerance K= $\pm 10\%$, M= $\pm 20\%$, T= $\pm 30\%$

1. Isat: Based on inductance change (△L/Lo: drop 10% Max.) @ambient temperature 25°C

2. Irms : Based on temperature rise ($\triangle T$: 40 $^{\circ}$ C TYP.)

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6 Electrical Characteristics:

Part No.	Inductance L(µH)	Test Frequency	Resistance RDC(Ω) Max.	Rated DO	C Current Irms(A)	Tolerance	Marking
BPCI00121260271 00	270	100kHz/0.25V	0.46	0.75	0.75	K,M	271
BPCI00121260331 00	330	100kHz/0.25V	0.51	0.68	0.68	K,M	331
BPCI00121260391 00	390	100kHz/0.25V	0.69	0.65	0.65	K,M	391
BPCI00121260471 00	470	100kHz/0.25V	0.77	0.58	0.58	K,M	471
BPCI00121260561 00	560	100kHz/0.25V	0.86	0.54	0.54	K,M	561
BPCI00121260681 00	680	100kHz/0.25V	1.20	0.48	0.48	K,M	681
BPCI00121260751 00	750	100kHz/0.25V	1.27	0.45	0.45	K,M	751
BPCI00121260821 00	820	100kHz/0.25V	1.34	0.43	0.43	K,M	821
BPCI00121260102 = 00	1000	100kHz/0.25V	1.53	0.40	0.40	K,M	102
BPCI00121260122 00	1200	100kHz/0.25V	1.72	0.34	0.34	K,M	122

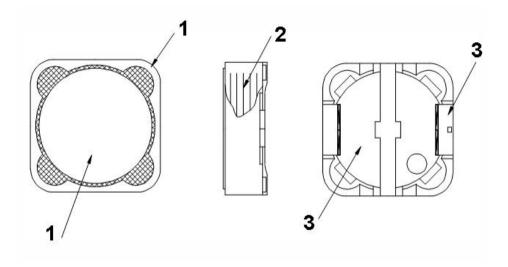
NOTE: tolerance K=±10%, M=±20%, T=±30%

1. Isat: Based on inductance change (△L/Lo: drop 10% Max.) @ambient temperature 25°C

2. Irms: Based on temperature rise (△T: 40°C TYP.)



6 6.1 Construction:



6.2 Material List:

NO.	ITEM	DESCRIPTION & TYPE
1	CORE	FERRITE
2	WIRE	MAGNET WIRE (P180)
3	TERMINAL	Ag/Cu/Ni/Sn

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ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	△L/L20℃ ≤±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		in figure 1 and a load applied unitil the figure in the arrow
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)
	no mechanical	PCB dimension shall the page 7/9
	damage or elec-	F(Pressurization)
	trical damage.	\Box
		R5 45±2 45±2
		10 20 R340
		PRESSURE ROD figure-1

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MECHANICAL

TEST ITEM		SPECIFICATION			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
-	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130∼150℃ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			
Resistance to	There shall be	Temperature profile of reflow soldering			
Soldering heat	no damage or				
(reflow soldering)	problems.	Temperature			
		Ramp up: Ramp down:			
		3°C/sec. max. 6°C/sec. max.			
		260°C			
		217°C			
		160°C ↔			
		Soldering			
		260°C ±3 °C 10 - 30 sec.			
		25°C Time			
		← Preheat → ← Liquidus → 150-200°C >217°C			
		60-120 sec. 60-150 sec.			
		The enesimen shall be necessal through the reflect even with the			
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.			
		The specimen shall be stored at standard atmospheric conditions			
		for 1 hour, after which the measurement shall be made.			

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ENVIRONMENT CHARACTERISTICS

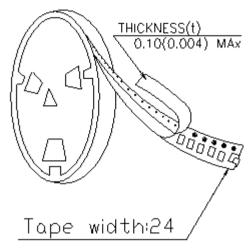
TEST ITEM				SPECIFICATION				
High temperature	∆L/Lo≦±5%	The san	The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperature of 125 $^{\circ}$ C and a normal humidity.						
	There shall be	Upon co	Upon completion of the measurement shall be made after the					
	no mechanical	sample	sample has been left in a normal temperature and normal					
	damage.	humidity for 1 hour.						
Low temperature	∆L/Lo≦±5%	The san	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a temperature of -40±3 $^{\circ}$ C.						
	There shall be	Upon co	Upon completion of the test, the measurement shall be made					
	no mechanical	after the	e samp	ole has been left in a no	mal temperature and			
	damage.	normal	humid	ity for 1 hour.				
Change of	∆L/Lo≦±5%	The san	nple sl	nall be subject to 5 cont	inuos cycles, such as sho	own		
temperature		in the ta	in the table 2 below and then it shall be subjected to standard					
	There shall be	atmospheric conditions for 1 hour, after which measurement						
	no other dama-	shall be made.						
	ge of problems							
			table 2					
				Temperature	Duration			
			1	−40±3 ℃	30 min.			
			'	(Themostat No.1)	30 mm.			
			2	Standard	No.1→No.2			
			_	atmospheric	NO.1→NO.2			
			3	125±2℃	20 min			
				(Themostat No.2)	30 min.			
			4	Standard	No.2→No.1			
			4	atmospheric	140.2-7140.1			
Moisture storage	∆L/Lo≦±5%	The san	nple sl	nall be left for 96±4 hour	s in a temperature of			
		40±2℃	and a	humidity(RH) of 90 \sim 95 $^\circ$	⁄₀.			
	There shall be	Upon co	omplet	ion of the test, the mea	surement shall be made			
	no mechanical	after the	e samp	ole has been left in a no	mal temperature and			
	damage.	normal humidity more than 1 hour.						

The sample shall be reflow soldered onto the printed circuit board in every test.



7 Packaging:

7.1 Packaging -Cover Tape

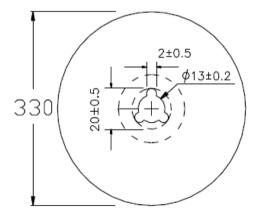


7.2 Packaging Quantity

TYPE	PCS/REEL
BPCI00121260	500

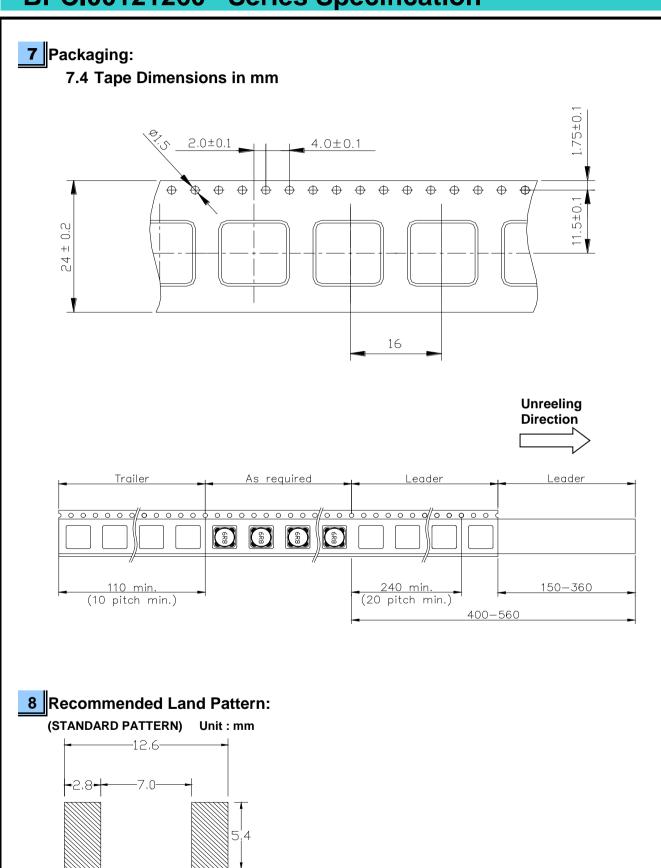
7.3 Reel Dimensions

Unit: mm



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9 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock or drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. The moisture sensitivity level (MSL) of products is classified as level 1.

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